

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Canceled)

2. (Previously Presented) The power amplifier according to claim ~~6~~¹ wherein said active element comprises a VLSI CMOS transistor.

3. (Previously Presented) The power amplifier according to claim ~~6~~¹ wherein said active element comprises a high frequency bipolar transistor.

4. (Original) The power amplifier according to claim 2 wherein said DMOS transistor is sized and biased so that the VLSI CMOS transistor works in saturation area and complies with a relation:

$$V_x \geq (V_{g2} - V_{th2})$$

wherein:

PN V_x is a voltage value on a terminal of said VLSI CMOS transistor;

V_{g2} is a voltage value on a control terminal of said VLSI CMOS transistor; and

V_{th2} is a threshold voltage value of said VLSI CMOS transistor.

5. (Previously Presented) The power amplifier according to claim ~~6~~¹ wherein said load element has a control terminal to receive a first control voltage being set so that the active element works in a saturation area.

~~1~~ ~~6~~. (Currently Amended) A power amplifier of a type, comprising:

at least a load element and at least an active element inserted, in series to each other, between first and second voltage references, wherein said load element includes a DMOS transistor, ~~and wherein said active element includes~~

a resistive element inserted between a circuit node connecting said active element to said load element and said second voltage reference.

7. (Canceled)

8. (Previously Presented) The apparatus of claim ⁶ ~~11~~ wherein the load element comprises a DMOS transistor.

9. (Previously Presented) The apparatus of claim ⁶ ~~11~~ wherein the active element comprises a VLSI CMOS transistor.

10. (Previously Presented) The apparatus of claim ⁶ ~~11~~ wherein the active element comprises a bipolar transistor.

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⁶ ~~11~~. (Currently Amended) An apparatus, comprising:

a load element having a first terminal coupled to a first voltage reference, a second terminal coupled to receive a first control voltage, and a third terminal coupled to a node; and

an active element in cascode configuration and having a first terminal coupled to the third terminal of the load element at the node, a second terminal coupled to receive a second control voltage, and a third terminal coupled to a second voltage reference; and

a resistive element coupled between the ~~third terminal of the load element and the second voltage reference~~ first and third terminals of the active element to stabilize a ~~the node at the third terminal of the load element~~ first terminal of the active element,

wherein the second control voltage is set and integration limits of the load element are fixed to allow the active element to operate in a saturation area to provide high

cutoff frequency and a high transconductance value and in a linear area to prove low activation resistance.

⁷~~12~~ (Previously Presented) The apparatus of claim ⁶~~11~~ wherein the load element and the active element are coupled to provide a high breakdown voltage in the saturation area.

13. (Canceled)

¹²~~14~~ (Previously Presented) The power amplifier of claim ¹¹~~17~~ wherein the transistor load element and the active element are coupled to provide a high breakdown voltage in the saturation area.

¹³~~15~~ (Previously Presented) The power amplifier of claim ¹¹~~17~~ wherein the transistor load element comprises a DMOS transistor.

¹⁴~~16~~ (Previously Presented) The power amplifier of claim ¹¹~~17~~ wherein the active element comprises either a VLSI CMOS transistor or a bipolar transistor.

¹¹~~17~~ (Currently Amended) A power amplifier usable in radio frequency applications, the power amplifier comprising:

first and second voltage references;

a transistor load element having a first terminal coupled to the first voltage reference, a second terminal coupled to receive a first control voltage, and a third terminal coupled to a node;

an active element in cascode configuration and having a first terminal coupled to the third terminal of the transistor load element at the node, a second terminal coupled to a second control voltage, and a third terminal coupled to the second voltage reference, wherein the transistor load element is sized and biased and the second control voltage is set to allow the

active element to operate in a saturation area to provide high cutoff frequency and a high transconductance value and in a linear area to provide low activation resistance; and

a resistive element coupled between the ~~third terminal of the transistor load element and the second voltage reference~~ first and third terminals of the active element in a manner that a first terminal of the resistive element is coupled to the node and a second terminal of the resistive element is coupled to the second voltage reference.

18. (Canceled)

¹⁵~~19~~ (Currently Amended) A method, comprising:

sizing and biasing a transistor load element to allow an active element to operate in a saturation area;

receiving a first control voltage at a control terminal of the load element to allow the active element to operate in the saturation area;

^{PN} setting a second control voltage at a control terminal of the active element to allow the active element to operate in the saturation area; and

obtaining high cutoff frequencies and high transconductance values in the saturation area, and obtaining low on-state resistance values in a linear area of operation; and

stabilizing a circuit node between the transistor load element and the active element with a resistive element having a first terminal coupled to the circuit node and a second terminal coupled to a voltage reference.

¹⁶~~20~~ (Previously Presented) The method of claim ¹⁵~~19~~, further comprising obtaining high breakdown voltage values in the saturation area.

21. (Canceled)

¹⁸~~22~~ (Previously Presented) The apparatus of claim ¹⁷~~23~~, further comprising a means for obtaining high breakdown voltage values in the saturation area.

¹⁷~~23~~. (Currently Amended) An apparatus, comprising:

means for sizing and biasing a transistor load element to allow an active element to operate in a saturation area;

means for receiving a first control voltage at a control terminal of the load element to allow the active element to operate in the saturation area;

means for setting a second control voltage at a control terminal of the active element to allow the active element to operate in the saturation area; and

means for obtaining high cutoff frequencies and high transconductance values in the saturation area, and for obtaining low on-state resistance values in a linear area of operation; and

means for stabilizing a circuit node between the transistor load element and the active element, the means for stabilizing being coupled between a pair of terminals of the active element that are different from the control terminal of the active element.

¹⁹~~24~~. (Previously Presented) The apparatus of claim ¹⁷~~23~~ wherein the means for stabilizing the circuit node comprises a resistive element.